

**METHOD OF MANUFACTURING SOLID STATE IMAGE PICK UP DEVICE  
HAVING MICROLENSES**

**Abstract of the Disclosure**

A method of manufacturing a solid state image pick up device, which is capable of increasing the hardness of a microlens is provided. A plurality of photosensing device arrays are formed on a semiconductor substrate. Next, a plurality of microlenses are formed on the semiconductor substrate on which the photosensing device arrays are formed. Next, the surfaces of the microlenses are hardened by irradiating light into the microlenses.

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